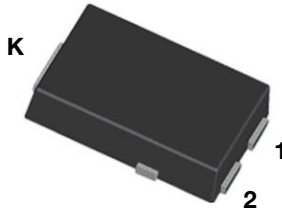
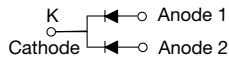


High Current Density Surface-Mount TMBS[®] (Trench MOS Barrier Schottky) Rectifier

 Ultra Low $V_F = 0.61\text{ V}$ at $I_F = 2.5\text{ A}$
eSMP[®] Series

SMPC (TO-277A)

LINKS TO ADDITIONAL RESOURCES

FEATURES

- Very low profile - typical height of 1.1 mm
- Ideal for automated placement
- Trench MOS Schottky technology
- Low forward voltage drop, low power losses
- High efficiency
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
- Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912


**RoHS
COMPLIANT
HALOGEN
FREE**
TYPICAL APPLICATIONS

For use in low voltage high frequency inverters, freewheeling, DC/DC converters and polarity protection applications.

MECHANICAL DATA
Case: SMPC (TO-277A)

Molding compound meets UL 94 V-0 flammability rating
Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Base P/NHM3 - halogen-free, RoHS-compliant and AEC-Q101 qualified

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

| PRIMARY CHARACTERISTICS | |
|-----------------------------|----------------|
| $I_{F(AV)}$ | 2 x 5.0 A |
| V_{RRM} | 200 V |
| I_{FSM} | 90 A |
| V_F at $I_F = 5\text{ A}$ | 0.69 V |
| T_J max. | 175 °C |
| Package | SMPC (TO-277A) |
| Circuit configuration | Common cathode |

| MAXIMUM RATINGS ($T_A = 25\text{ °C}$ unless otherwise noted) | | | |
|--|----------------------------|-------------|------|
| PARAMETER | SYMBOL | V10P22C | UNIT |
| Device marking code | | V1022C | |
| Maximum repetitive peak reverse voltage | V_{RRM} | 200 | V |
| Maximum average forward rectified current per device (fig. 1) | $I_{F(AV)}$ ⁽¹⁾ | 10 | A |
| | $I_{F(AV)}$ ⁽²⁾ | 3.2 | |
| Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load per diode | I_{FSM} | 90 | A |
| Operating junction temperature range | T_J ⁽³⁾ | -40 to +175 | °C |
| Storage temperature range | T_J, T_{STG} | -55 to +175 | °C |

Notes

⁽¹⁾ Mounted on 30 mm x 30 mm pad areas aluminum PCB

⁽²⁾ Free air, mounted on recommended pad area

⁽³⁾ The heat generated must be less than the thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$



| ELECTRICAL CHARACTERISTICS ($T_J = 25\text{ }^\circ\text{C}$ unless otherwise noted) | | | | | | |
|---|----------------------|-----------------------------------|-------------|--------|------|------|
| PARAMETER | TEST CONDITIONS | | SYMBOL | TYP. | MAX. | UNIT |
| Instantaneous forward voltage per diode | $I_F = 2.5\text{ A}$ | $T_J = 25\text{ }^\circ\text{C}$ | $V_F^{(1)}$ | 0.76 | - | V |
| | $I_F = 5.0\text{ A}$ | | | 0.83 | 0.93 | |
| | $I_F = 2.5\text{ A}$ | $T_J = 125\text{ }^\circ\text{C}$ | | 0.61 | - | |
| | $I_F = 5.0\text{ A}$ | | | 0.69 | 0.75 | |
| Reverse current per diode | $V_R = 160\text{ V}$ | $T_J = 25\text{ }^\circ\text{C}$ | $I_R^{(2)}$ | 0.0003 | - | mA |
| | | $T_J = 125\text{ }^\circ\text{C}$ | | 0.5 | - | |
| | $V_R = 200\text{ V}$ | $T_J = 25\text{ }^\circ\text{C}$ | | - | 0.1 | |
| | | $T_J = 125\text{ }^\circ\text{C}$ | | 1.0 | 5 | |
| Typical junction capacitance per diode | 4.0 V, 1 MHz | | C_J | 205 | - | pF |

Notes

- (1) Pulse test: 300 μs pulse width, 1 % duty cycle
(2) Pulse test: Pulse width $\leq 40\text{ ms}$

| THERMAL CHARACTERISTICS ($T_A = 25\text{ }^\circ\text{C}$ unless otherwise specified) | | | |
|--|--------------------------|---------|--------------------|
| PARAMETER | SYMBOL | V10P22C | UNIT |
| Typical thermal resistance per device | $R_{\theta JA}^{(1)(2)}$ | 85 | $^\circ\text{C/W}$ |
| | $R_{\theta JM}^{(3)}$ | 5 | |

Notes

- (1) The heat generated must be less than the thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$
(2) Free air, mounted on recommended copper pad area, 2 oz., FR4 PCB, thermal resistance $R_{\theta JA}$ - junction-to-ambient
(3) Units mounted on 30 mm x 30 mm aluminum PCB, thermal resistance $R_{\theta JM}$ - junction-to-mount

| ORDERING INFORMATION (Example) | | | | |
|--------------------------------|-----------------|--------------|---------------|------------------------------------|
| PREFERRED P/N | UNIT WEIGHT (g) | PACKAGE CODE | BASE QUANTITY | DELIVERY MODE |
| V10P22C-M3/H | 0.10 | H | 1500 | 7" diameter plastic tape and reel |
| V10P22C-M3/I | 0.10 | I | 6500 | 13" diameter plastic tape and reel |
| V10P22CHM3/H ⁽¹⁾ | 0.10 | H | 1500 | 7" diameter plastic tape and reel |
| V10P22CHM3/I ⁽¹⁾ | 0.10 | I | 6500 | 13" diameter plastic tape and reel |

Note

- (1) AEC-Q101 qualified

RATINGS AND CHARACTERISTICS CURVES ($T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)

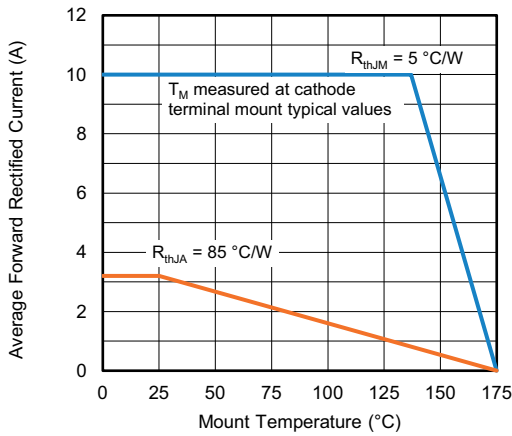


Fig. 1 - Maximum Forward Current Derating Curve

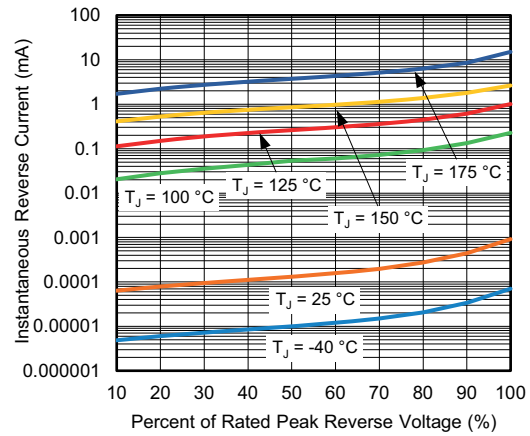


Fig. 4 - Typical Reverse Leakage Characteristics Per Diode

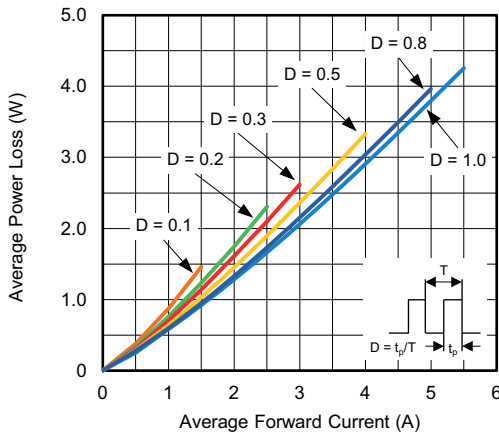


Fig. 2 - Forward Power Loss Characteristics Per Diode

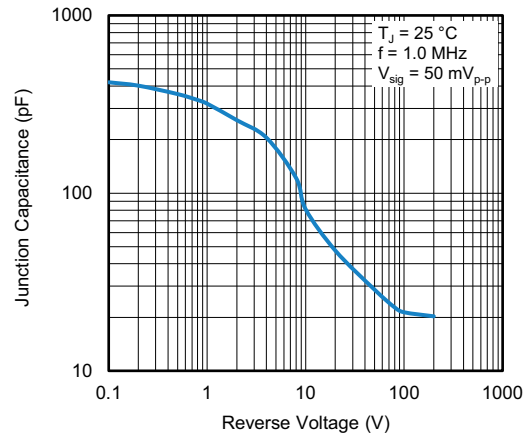


Fig. 5 - Typical Junction Capacitance Per Diode

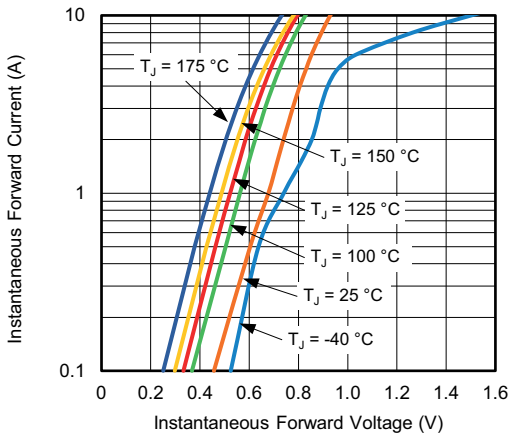


Fig. 3 - Typical Instantaneous Forward Characteristics Per Diode

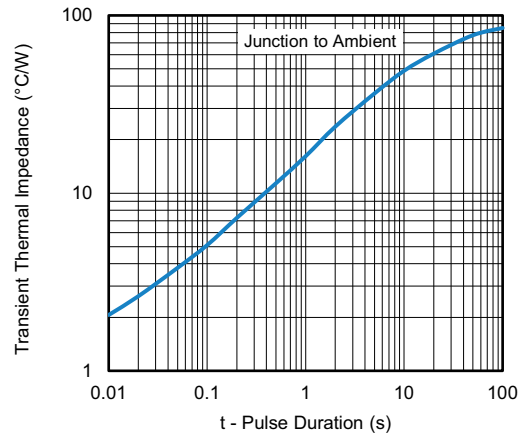
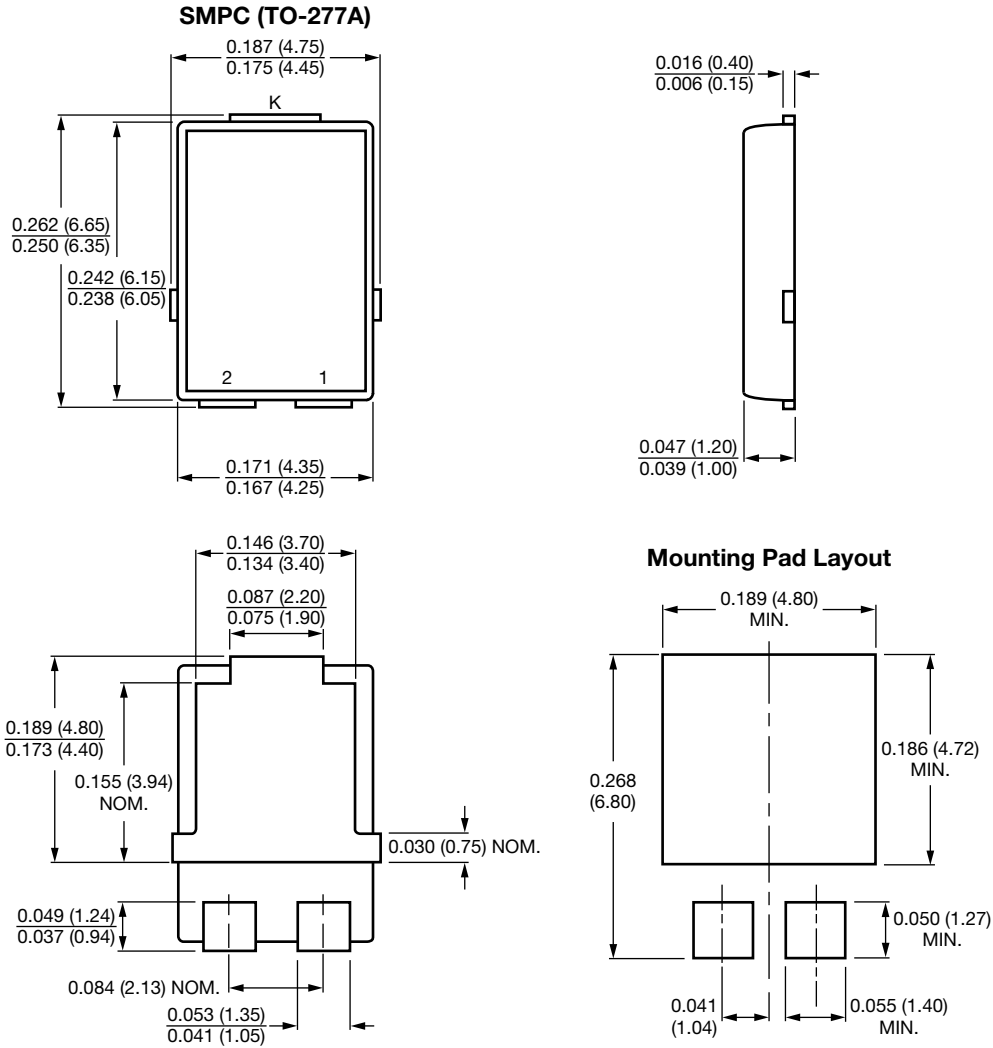


Fig. 6 - Typical Transient Thermal Impedance



PACKAGE OUTLINE DIMENSIONS in inches (millimeters)



Conform to JEDEC® TO-277A



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